



Corpay to Participate in Upcoming Investor Conferences

February 10, 2026

ATLANTA--(BUSINESS WIRE)--Feb. 10, 2026-- Corpay, Inc., (NYSE: CPAY), the corporate payments company, today announced that the Company will participate in the following investor conferences:

- On Wednesday, February 11, 2026, the Company will be attending the Bank of America Financial Services Conference in Miami, FL.
- On Monday, March 2, 2026, the Company will be attending the Raymond James 47th Annual Institutional Investors Conference in Orlando, FL. Management will participate in a fireside chat beginning at 2:50 PM ET.
- On Tuesday, March 10, 2026, the Company will be attending the Wolfe FinTech Forum in New York, NY. Management will participate in a fireside chat at 10:55am ET.

Investors and interested parties can access the Raymond James presentation by visiting the Company's investor relations website at <https://investor.corpay.com/>.

About Corpay

Corpay (NYSE: CPAY), the Corporate Payments Company, is a global S&P 500 provider of commercial cards (e.g, business cards, fleet cards, virtual cards) and AP modernization solutions (e.g., invoice and payments automation, cross border payments) to businesses worldwide. Our solutions "keep business moving" and result in our customers better controlling purchases, mitigating fraud, and ultimately spending less. To learn more visit www.corpay.com.

Source: Corpay, Inc.

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Corpay Investor Relations

Jim Eglseder
Jim.Eglseder@corpay.com
770-417-4697

Source: Corpay, Inc.